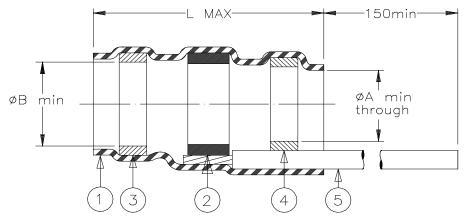
CUSTOMER DRAWING



Part Names	Product Dimensions				Cable Dimensions				
	L	A	В	K	D	Е	F	G	J±0.5
	max	min	min	min	max	min	min	max	(± 0.02)
B-900-20	17.2	2.6	3.1	150	2.6	1.8	1.55	3.1	7
	(0.680)	(0.100)	(0.120)	(5.900)	(0.100)	(0.071)	(0.060)	(0.120)	(0.275)
B-900-21	17.2	4.3	4.9	150	4.3	2.4	2.2	4.9	7
	(0.680)	(0.170)	(0.195)	(5.900)	(0.170)	(0.095)	(0.090)	(0.195)	(0.275)
B-900-22	20.8	6.9	7.4	150	6.9	3.6	3.3	7.4	7
	(0.820)	(0.270)	(0.290)	(5.900)	(0.270)	(0.145)	(0.131)	(0.290)	(0.275)
B-900-23	31.2	10.7	11.6	150	10.7	4.4	4.0	11.6	7
	(1.230)	(0.420)	(0.457)	(5.900)	(0.420)	(0.175)	(0.155)	(0.455)	(0.275)

MATERIAL

- 1. INSULATION SLEEVE: Heat-shrinkable, radiation cross-linked modified polyvinylidene fluoride. Transparent blue.
- 2. SOLDER PREFORM WITH FLUX:

SOLDER: TYPE Sn63 per ANSI J-STD-006.

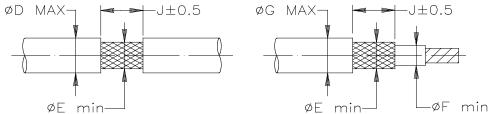
FLUX: TYPE ROL0 per ANSI J-STD-004.

- 3. & 4. MELTABLE RINGS: Thermally stabilized thermoplastic.
- 5. GROUND LEAD: RAYCHEM 44A0211-20 stranded AWG20 tin plated copper.

APPLICATION

- 1. These parts are designed to provide an environment protected shield termination on cables rated for 125°C minimum, meeting the dimensional criteria listed and having bare or tin plated copper shields.
- 2. Temperature range: -55°C to +150°C.
- 3. Install using TE Connectivity approved convection or infrared tools in accordance with TE Connectivity/Raychem process standard RCPS-100-70.

For best results, prepare the cable as shown:



= TE				<i>Raychem</i> THERMOFIT DEVICES	SOLDERSLEEVE* DEVICE WITH PRE-INSTALLED LEAD				
Unless otherwise specified dimensions are in millimeters. [Inches dimensions are shown in brackets]				DOCUMENT NO.: B-900-2X					
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A		ES: N/A HNESS IN ON	amen Users	onnectivity reserves the right to d this drawing at any time. should evaluate the suitability product for their application.	REV:		DATE: 24-Jul-2020		
DRAWN BY: DATE: R. MAPALO 16-Oct-1		ECO: ECO-20-010292		SCALE: NTS		SIZE: A	SHEET: 1 of 1		

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